

PolarHT[™] Power MOSFET

IXTQ 120N15P IXTT 120N15P

 $V_{DSS} = 150 V$ $I_{D25} = 120 A$ $R_{DS(on)} \le 16 m\Omega$

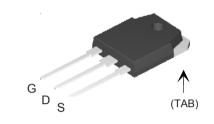
N-Channel Enhancement Mode Avalanche Rated



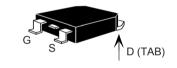
Symbol	Test Conditions	Maximum Ratings		
V _{DSS} V _{DGR}	$T_J = 25^{\circ} \text{ C to } 175^{\circ} \text{ C}$ $T_J = 25^{\circ} \text{ C to } 175^{\circ} \text{ C}; R_{GS} = 1 \text{ M}\Omega$	150 150	V	
V _{DSS} V _{GSM}	Continuous Transient	±20 ±30	V	
I _{D25}	T _C =25°C	120	Α	
I _{D(RMS)}	External lead current limit	75	Α	
I _{DM}	$T_{\rm C}$ = 25° C, pulse width limited by $T_{\rm JM}$	260	Α	
I _{AR}	T _C = 25° C	60	Α	
E _{AR}	T _C = 25° C	60	mJ	
E _{as}	T _C = 25° C	2.0	J	
dv/dt	$I_{S} \leq I_{DM}$, di/dt ≤ 100 A/ μ s, $V_{DD} \leq V_{DSS}$, $T_{J} \leq 150$ °C, $R_{G} = 4$ Ω	10	V/ns	
P _D	T _C =25°C	600	W	
T _J		-55 +175	°C	
T _{IM}		175	°C	
T _{stg}		-55 +150	°C	
T _L	1.6 mm (0.062 in.) from case for 10 s	300	°C	
T _{SOLD}	Plastic body for 10 s	260	°C	
M _d	Mounting torque (TO-3P)	1.13/10	Nm/lb.in.	
Weight	TO-3P TO-268	5.5 5.0	g g	

Symbol (T _J = 25° C, t	Test Conditions unless otherwise specified)		Ch Min.	istic Va Max	
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		150		V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		3.0	5.0	V
I _{GSS}	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T _J = 175° C		25 500	μA μA
R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}$ Pulse test, t ≤300 µs, duty of	cycle d ≤ 2 %		16	mΩ

TO-3P (IXTQ)



TO-268 (IXTT)



G = Gate D = Drain S = Source TAB = Drain

Features

- ¹ International standard packages
- Unclamped Inductive Switching (UIS) rated
- 1 Low package inductance
 - easy to drive and to protect

Advantages

- ^I Easy to mount
- Space savings
- High power density

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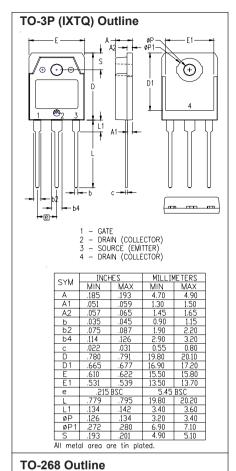


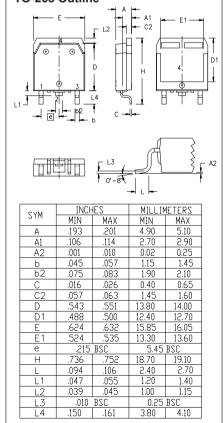
Symbo	ol	Test Conditions $(T_{_{J}} = 25^{\circ}\text{C, ur}$ Mi	les		ristic Values ise specified) Max.
\mathbf{g}_{fs}		V_{DS} = 10 V; I_{D} = 0.5 I_{D25} , pulse test	40	60	S
\mathbf{C}_{iss})			4900	pF
$\mathbf{C}_{\mathrm{oss}}$	}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1300	pF
C _{rss}	J			330	pF
$\mathbf{t}_{d(on)}$)			33	ns
t _r		$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 60 \text{ A}$		42	ns
$\mathbf{t}_{d(off)}$		$R_{G} = 4 \Omega \text{ (External)}$		85	ns
t _f)			26	ns
$\mathbf{Q}_{g(on)}$)			150	nC
\mathbf{Q}_{gs}	}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{D25}$		40	nC
\mathbf{Q}_{gd}	J			80	nC
$R_{\scriptscriptstyle thJC}$					0.25° C/W
$\mathbf{R}_{\mathrm{thCS}}$		(TO-3P)		0.21	° C/W

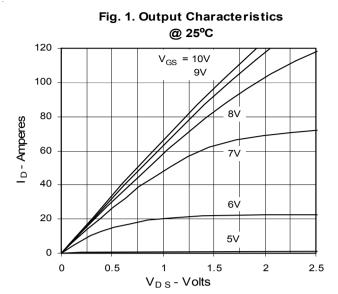
Source-Drain Diode

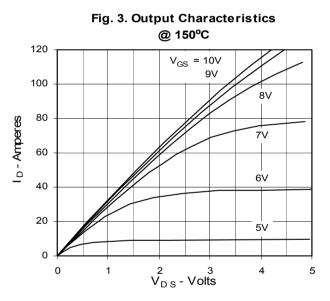
Characteristic Values (T, = 25°C, unless otherwise specified)

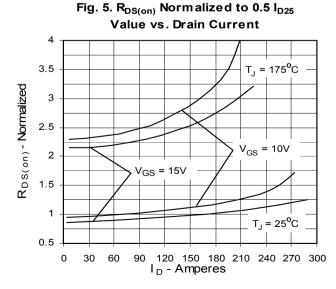
Symbol	Test Conditions	Min.	∣Тур.	Max.	
I _s	V _{GS} = 0 V			120	Α
I _{SM}	Repetitive			260	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0$ V, Pulse test, t ≤300 μ s, duty cycle d≤ 2 %			1.5	V
$\left\{egin{array}{c} \mathbf{t}_{rr} & \ \mathbf{Q}_{RM} \end{array}\right\}$	$I_F = 25 \text{ A}, -di/dt = 100 \text{ A}/\mu\text{s}$ $V_R = 100 \text{ V}, V_{GS} = 0 \text{ V}$		150 2.3		ns μC

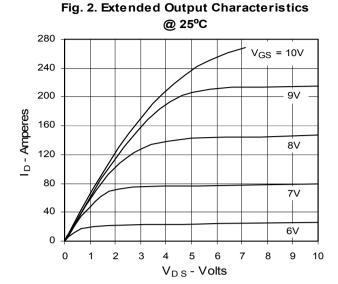












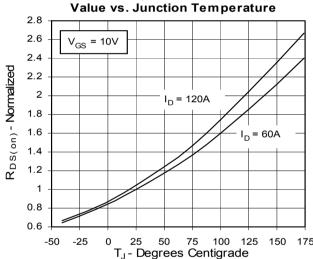
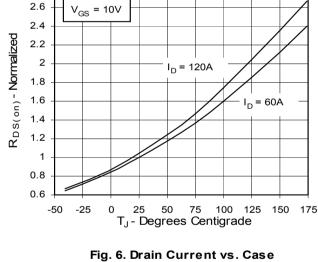
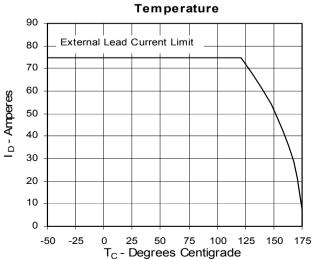


Fig. 4. R_{DS(on)} Normalized to 0.5 I_{D25}





Is-Amperes

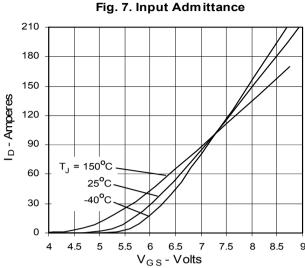
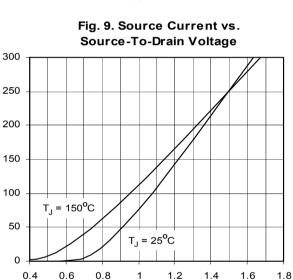
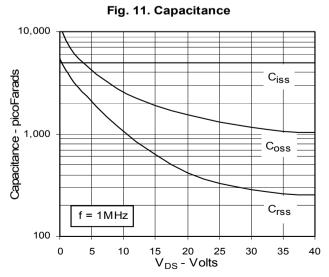
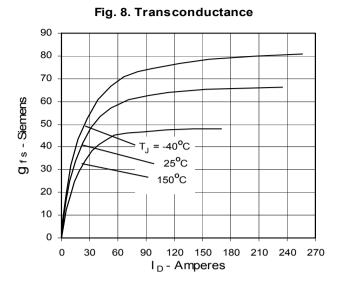


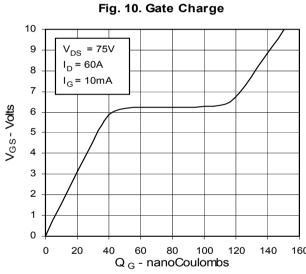
Fig. 9. Source Current vs.

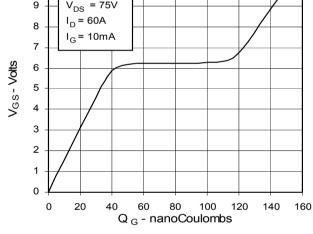


V_{SD} - Volts









 $T_{J} = 175^{\circ}C$ T_C = 25°C R_{DS(on)} Limit I_D - Amperes 25µs 100 100µs 1ms 10ms

V_{DS} - Volts

1000

DC

Fig. 12. Forward-Bias

Safe Operating Area

1000

10

10

IXYS reserves the right to change limits, test conditions, and dimensions.



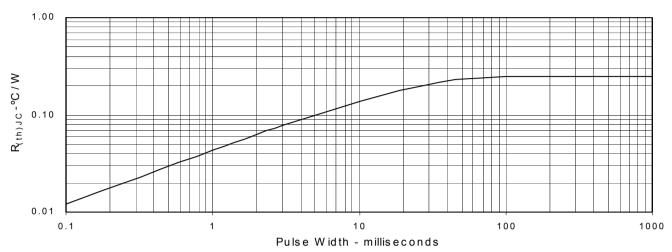


Fig. 13. Maximum Transient Thermal Resistance

